

FDG6342L Integrated Load Switch

Features

- Max $r_{DS(on)} = 150 m\Omega$ at $V_{GS} = 4.5 V$, $I_D = -1.5 A$
- Max $r_{DS(on)} = 195 m\Omega$ at $V_{GS} = 2.5 V$, $I_D = -1.3 A$
- Max $r_{DS(on)} = 280 m\Omega$ at $V_{GS} = 1.8 V$, $I_D = -1.1 A$
- Max $r_{DS(on)}$ = 480m Ω at V_{GS} = 1.5V, I_D = -0.9A
- Control MOSFET (Q1) includes Zener protection for ESD ruggedness (>4KV Human body model)
- High performance trench technology for extremely low r_{DS(on)}
- Compact industry standard SC70-6 surface mount package
- RoHS Compliant

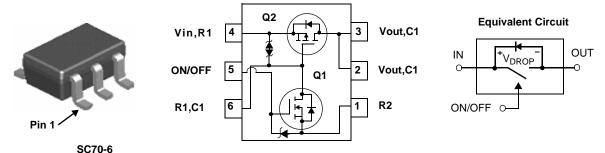


General Description

This device is particularly suited for compact power management in portable electronic equipment where 2.5V to 8V input and 1.5A output current capability are needed. This load switch integrates a small N-Channel power MOSFET (Q1) that drives a large P-Channel power MOSFET (Q2) in one tiny SC70-6 package.

Applications

- Power management
- Load switch



See Application Circuit

MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{IN}	Gate to Source Voltage (Q2)	e to Source Voltage (Q2)			
V _{ON/OFF}	Gate to Source Voltage (Q1)		-0.5 to 8	V	
1	Load Current -Continuous	(Note 2)	-1.5	•	
Load	-Pulsed	(Note 2)	-6	A	
6	Power Dissipation for Single Operation	(Note 1a)	0.36	14/	
P _D		(Note 1b)	0.3	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C	

Thermal Characteristics

R_{\thetaJA}	Thermal Resistance, Junction to Ambient Single operation	(Note 1a)	350	°C ///
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient Single operation	(Note 1b)	415	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
.2L	FDG6342L	SC70-6	7"	8mm	3000units

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Max

Units

Тур

Min

Off Char						
ΒV _{IN}	V _{IN} Breakdown Voltage	$I_D = -250 \mu A, V_{ON/OFF} = 0V$	8			V
Load	Zero Gate Voltage Drain Current	$V_{IN} = -6.4V, V_{ON/OFF} = 0V$			-1	μΑ
FL	Leakage Current, Forward	$V_{IN} = 8V, V_{ON/OFF} = 0V$			10	μΑ
RL	Leakage Current, Reverse	$V_{IN} = -8V, V_{ON/OFF} = 0V$			-10	μΑ
On Char	acteristics (note 2)					
VON/OFF(th)	Gate Threshold Voltage	$V_{IN} = V_{ON/OFF}, I_D = -250 \mu A$	0.65	0.8	1.5	V
		V _{IN} = 4.5V, I _D = -1.5A		125	150	
	Static Drain to Source On Resistance (Q2)	$V_{IN} = 2.5V, I_D = -1.3A$		150	195	
DS(on)	Static Drain to Source On Resistance (Q2)	V _{IN} = 1.8V, I _D = -1.1A		200	280	mΩ
- (-)		V _{IN} = 1.5V, I _D = -0.9A		250	480	
	Static Drain to Source On Registence (01)	V _{IN} = 4.5V, I _D = 0.4A		2.6	4.0	0
	Static Drain to Source On Resistance (Q1)	V _{IN} = 2.7V, I _D = 0.2A		3.3	5.0	Ω
Drain-So	ource Diode Characteristics					
S	Maximum Continuous Drain to Source Diod				-0.25	V
∕ _{SD}	Source to Drain Diode Forward Voltage	$V_{ON/OFF} = 0V$, $I_S = -0.25A$ (Note 2)		-0.6	-1.2	V
	a. 350°C/W when mount 1 in ² pad of 2 oz cop				n mounted or ad of 2 oz cop	
	1 in ² pad of 2 oz cop					
2. Pulse Test:	1 in ² pad of 2 oz cop					
	1 in ² pad of 2 oz cop					
	1 in ² pad of 2 oz cop					

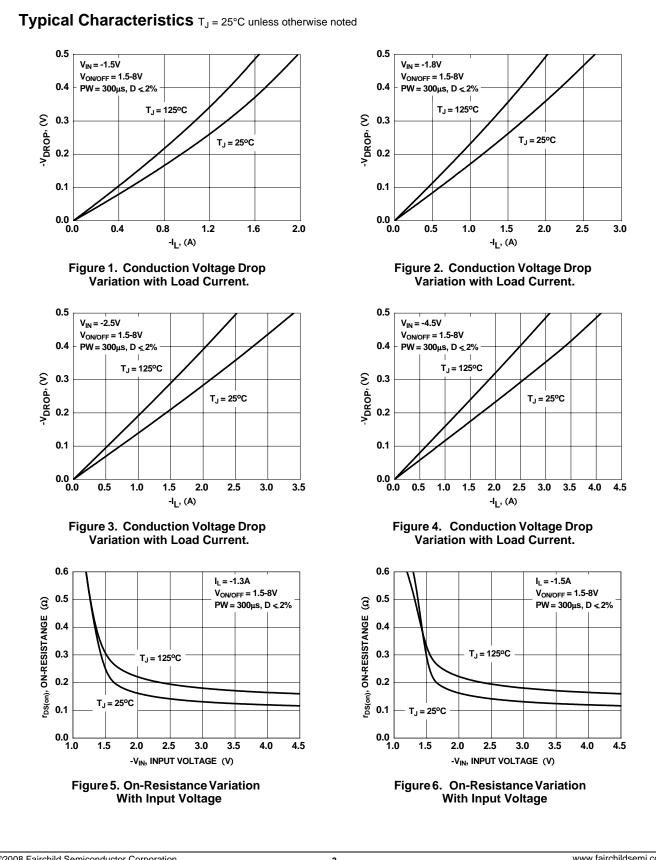
Test Conditions

Electrical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

Parameter

Symbol

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